

SJ-205C

## **Crosslinkable Semiconductive Shielding Compound**

#### Overview

SJ-205C is a outstanding crosslinkable semiconductive polyethylene copolymer compound for conductor and bonded insulation shielding of medium voltage XLPE insulated power cable. (up to 35 kV)

SJ-205C is compatible with copper and aluminum conductors. SJ-205C provides a super-smooth

surface yielding virtually perfect interface between the extruded shield and insulation. Significantly improved cable performance can be expected.

SJ-205C provides high resistance to scorch and fast extrusion processability.

### **Specifications**

ICEA S-93-639, ICEA S-94-649

IEC 60502-2

AEIC CS7, AEIC CS8

UL 1072

#### **Properties**

This TDS is typical data only and are not to be construed as specifications. Users should results their own test. Tests are conducted on compression molded slabs cured 15 minutes at 180℃.

Physical Density Moisture Content Melt Flow Rate[125°C(257°F)/10.0 kg] Brittleness temperature	Value (English) 1.13 g/m³ 300 ppm 2.00 g/10min <-50 °C	Value (SI)  1.13 g /m³  300 ppm  2.00 g/10min <-50 °C	Test Method ASTM D 1505 ASTM D 6869 ASTM D 1238 ASTM D 746
Mechanical Ultimate Tensile Strength Elongation at Break Retention of Tensile Strength After Ageing - 135°C[275°F], 168hrs Retention of Elongation After Ageing - 135°C[275°F], 168hrs	Value (English) 2756 psi 180 % 85 % 85 %	Value (SI) 19.0 Mpa 180 % 85 % 85 %	Test Method ASTM D 638 ASTM D 638 IEC 60811-401 IEC 60811-401
Electrical  Volume Resistivity  at 23 °C [73.4 °F]  at 90 °C [194 °F]  at 135 °C [275 °F]	Value (English)  500 Ωcm  1,000 Ωcm  2,000 Ωcm	<b>Value (SI)</b> 500 Ωcm 1,000 Ωcm 2,000 Ωcm	<b>Test Method</b> ASTM D 991

### **Processing**

SJ-205C provides excellent surface finish and outstanding output rates over a broad range of

extrusion conditions.

SJ-205C requires melt stock temperatures in the range of 110°C to 120°C for best results.

## **Product Data sheet**

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Lower melt temperatures may result in unmelted extrudate and higher melt temperatures may result in extrudate scorch and It can even trigger die-drools.

The curing configuration: the maximum cable surface temperature in the curing zone should be maintained below 200°C. If the surface temperature of the cable in the curing zone is over 200°C, it may cause cracks in the cable, so careful temperature control is required. Dehumidified hopper drying at 60~70°C for up to 4 hours prior to extrusion could help remove moisture. Specific processing conditions depend on equipment and cable dimensions.

## **Packing & Storage**

Packed in 600kg polybag lined carton box.

Recommended maximum storage period is 12months unopened and in original packaging after the manufacture.

Stored at room temperatures 86  $^{\circ}\text{F}$  30  $^{\circ}\text{C}$ 

The shelf life of this product is 1 year from the date of manufacture.

Optimum conditions by conventional practices should be established.

## Safety

Please contact Seji Chemical for Material Safety Data Sheet.

#### **Disclaimer**

Information contained in this data sheet is up-to-date and correct as at the date of issue.

Seji chemical Co., Ltd. cannot control or anticipate the conditions under which this product may be used, each user should review the information in specific context of the planned use.

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